

# **Film Capacitors**

Metallized Polyester Film Capacitors (MKT)

Series/Type: B32560 ... B32564

Date: July 2020

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#### General purpose (stacked) SilverCap™

#### **Typical applications**

- SMPS, converter
- Electronic ballasts
- Compact fluorescent lamps (CFL)
- Ignition

#### **Climatic**

- Max. operating temperature: 125 °C
- Climatic category (IEC 60068-1:2013): 55/125/56

#### **Features**

- Special dimensions available on request
- High pulse strength
- Small dimensions
- RoHS-compatible

#### Construction

- Dielectric: polyethylene terephthalate (polyester, PET)
- Stacked-film technology
- Uncoated

#### **Terminals**

- Parallel wire leads, lead-free tinned
- Special lead lengths available on request

#### Marking

Rated capacitance (coded), rated DC voltage

#### **Delivery mode**

Bulk (untaped)

Taped (Ammo pack or reel) for lead spacing ≤15.0 mm.

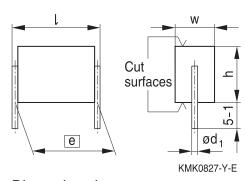
For notes on taping, refer to chapter "Taping and packing".

## Notes on mounting

When mounting these capacitors, take into account creepage distances and clearances to adjacent live parts. The insulating strength of the cut surfaces to other live parts of the circuit is 1.5 times the capacitors rated DC voltage, but is always at least 300 V DC.

Capacitors with 7.5 mm lead spacing are only suitable for use with single-clad printed circuit boards.

## **Dimensional drawing**



Dimensions in mm

Lead spacing	Lead diameter	Туре	
<i>e</i> ±0.4	d <sub>1</sub> ±0.05		
7.5	0.5	B32560	
15.0	0.6	B32562J	
	0.8	B32562H	
22.5	0.8	B32563	
27.5	0.8	B32564	





## General purpose (stacked) SilverCap™

## Overview of available types

Lead spacing	g 7.5 mm			15.0 mm			22.5 mm					
Туре	B3256	60				B3256	B32562			B325	63	
Page	5					7			8			
V <sub>R</sub> (V DC)	63	100	250	400	630	100	250	400	630	100	250	400
V <sub>RMS</sub> (V AC)	40	63	160	200	400	63	160	200	350	63	160	200
$C_R (\mu F)$												
0.0010												
0.0015												
0.0022												
0.0033												
0.0047												
0.0068												
0.010												
0.015												
0.022												
0.033												
0.047												
0.068												
0.10												
0.15												
0.22												
0.33												
0.47												
0.68												
1.0												
1.5												
2.2												
3.3												
4.7												
6.8												
10												
15												
22												





## General purpose (stacked) SilverCap™

## Overview of available types

Lead spacing	Lead spacing 27.5 mm						
Туре	B32564						
Page	9						
V <sub>R</sub> (V DC)	100	250	400	420			
V <sub>RMS</sub> (V AC)	63	160	200	200			
C <sub>R</sub> (μF)							
1.5							
2.2							
3.3							
4.7							
6.8							
10							
15							
22							
33							





#### Ordering codes and packing units (lead spacing 7.5 mm)

$V_R$	V <sub>RMS</sub>	C <sub>R</sub>	Max. dimensions	Ordering code	Ammo	Reel	Untaped
	f ≤60 Hz		$w \times h \times I$	(composition see	pack		
V DC	V AC	μF	mm	below)	pcs./MOQ	pcs./MOQ	pcs./MOQ
63	40	1.0	$4.0 \times 6.8 \times 9.0$	B32560J0105+***	8800	7200	4000
		1.5	$5.1 \times 7.6 \times 9.0$	B32560J0155+***	6800	5600	2000
		2.2	$6.5 \times 8.2 \times 9.0$	B32560J0225+***	6000	4800	2000
		3.3	$8.5 \times 9.1 \times 9.0$	B32560J0335+000	_	_	1400
		4.7	$9.8 \times 11.0 \times 9.0$	B32560J0475+000	_	_	1000
100	63	0.22	$2.5 \times 5.1 \times 9.0$	B32560J1224+***	12400	10000	7600
		0.33	$2.7 \times 5.7 \times 9.0$	B32560J1334+***	12000	9600	6000
		0.47	$3.4 \times 6.1 \times 9.0$	B32560J1474+***	9600	8000	4800
		0.68	$4.2 \times 6.5 \times 9.0$	B32560J1684+***	8000	6400	3600
		1.0	$5.5 \times 7.0 \times 9.0$	B32560J1105+***	6000	4800	2000
		1.5	$6.7 \times 8.2 \times 9.0$	B32560J1155+***	5000	4000	1600
		2.2	$8.5 \times 9.2 \times 9.0$	B32560J1225+000	_	_	1200
		3.3	$9.5 \times 11.0 \times 9.0$	B32560J1335+000	_	_	800
250	160	0.047	$2.5 \times 5.2 \times 9.0$	B32560J3473+***	13000	10400	7600
		0.068	$2.6 \times 5.7 \times 9.0$	B32560J3683+***	12400	10000	6800
		0.10	$3.2 \times 6.1 \times 9.0$	B32560J3104+***	12400	8000	4800
		0.15	$3.9 \times 7.0 \times 9.0$	B32560J3154+***	8200	6800	3600
		0.22	$4.9 \times 7.5 \times 9.0$	B32560J3224+***	6800	5200	2600
		0.33	$6.4 \times 8.2 \times 9.0$	B32560J3334+***	5200	4400	1800
		0.47	$7.4 \times 9.8 \times 9.0$	B32560J3474+000	_	_	1200
		0.68	$9.5\times11.0\times9.0$	B32560J3684+000	_	_	800

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further E series and intermediate capacitance values on request.

Special dimensions available on request.

For corresponding design rules, refer to chapter "General technical information", section 1.3.2.

#### Composition of ordering code

+ = Capacitance tolerance code:

 $M = \pm 20\%$ 

 $K = \pm 10\%$ 

 $J = \pm 5\%$ 

\*\*\* = Packaging code:

289 = Ammo pack

189 = Reel

000 = Untaped (lead length 5 - 1 mm)





#### General purpose (stacked) SilverCap™

#### Ordering codes and packing units (lead spacing 7.5 mm)

$V_R$	$V_{RMS}$	C <sub>R</sub>	Max. o	dimensions	Ordering code	Ammo	Reel	Untaped
	f ≤60 Hz		$\mathbf{w} \times \mathbf{h}$	×I	(composition see	pack		
V DC	V AC	μF	mm		below)	pcs./MOQ	pcs./MOQ	pcs./MOQ
400	200	0.0068	2.5 ×	$5.5 \times 9.0$	B32560J6682+***	14000	11200	7600
		0.010	2.5 ×	$5.5 \times 9.0$	B32560J6103+***	12800	10400	7200
		0.015	2.5 ×	$5.5 \times 9.0$	B32560J6153+***	13000	10400	7200
		0.022	2.5 ×	$5.5 \times 9.0$	B32560J6223+***	12400	10000	6800
		0.033	2.6×	$6.0 \times 9.0$	B32560J6333+***	12400	10000	6400
		0.047	3.2 ×	$6.5 \times 9.0$	B32560J6473+***	10400	8400	4800
		0.068	3.8 ×	$7.3 \times 9.0$	B32560J6683+***	8600	7200	3600
		0.10	4.9 ×	$7.7 \times 9.0$	B32560J6104+***	6800	5600	2000
		0.15	6.5 ×	$8.2 \times 9.0$	B32560J6154+***	5400	4000	1800
		0.22	7.7 ×	$9.8 \times 9.0$	B32560J6224+000		_	1200
630	400	0.0010	2.5 ×	$5.5 \times 9.0$	B32560J8102+***	14800	12000	9200
		0.0015	2.5 ×	$5.5 \times 9.0$	B32560J8152+***	13000	2600	7200
		0.0022	2.5 ×	$5.5 \times 9.0$	B32560J8222+***	13400	10800	7200
		0.0033	2.5 ×	$5.5 \times 9.0$	B32560J8332+***	14000	11200	7600
		0.0047	2.5 ×	$5.5 \times 9.0$	B32560J8472+***	13600	10800	7200
		0.0068	3.2 ×	$6.5 \times 9.0$	B32560J8682+***	15000	9200	5200
		0.010	3.8 ×	$7.5 \times 9.0$	B32560J8103+***	9000	9200	4000
		0.015	4.6 ×	$8.3 \times 9.0$	B32560J8153+000	_	_	2400
		0.022	5.7×	$8.6 \times 9.0$	B32560J8223+000	_	_	1600

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further E series and intermediate capacitance values on request.

Special dimensions available on request.

For corresponding design rules, refer to chapter "General technical information", section 1.3.2.

#### Composition of ordering code

+ = Capacitance tolerance code:

 $M = \pm 20\%$ 

 $K = \pm 10\%$ 

 $J = \pm 5\%$ 

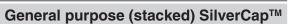
\*\*\* = Packaging code:

289 = Ammo pack

189 = Reel









#### Ordering codes and packing units (lead spacing 15 mm)

$V_R$	$V_{RMS}$	$C_R$	Max. dimensions	Ordering code	Ammo	Reel	Untaped
	f ≤60 Hz		$w \times h \times I$	(composition see	pack	pcs./	pcs./
V DC	V AC	μF	mm	below)	pcs./MOQ	MOQ	MOQ
100	63	2.2	4.9 × 8.0 × 16.5	B32562J1225+***	4760	5200	3200
		3.3	$6.0 \times 9.3 \times 16.5$	B32562J1335+***	3840	4000	2000
		4.7	$7.3 \times 10.6 \times 16.5$	B32562H1475+***	3160	3600	1600
		6.8	$9.0 \times 11.8 \times 16.5$	B32562H1685+***	2560	2800	1160
		10	$11.8 \times 13.0 \times 16.5$	B32562H1106+000	_	_	800
250	160	0.47	$5.0 \times 6.7 \times 16.5$	B32562J3474+***	4760	5200	3800
		0.68	$6.0 \times 7.8 \times 16.5$	B32562J3684+***	3840	4000	2000
		1.0	$7.0 \times 9.3 \times 16.5$	B32562J3105+***	3320	3600	2000
		1.5	$8.7 \times 11.0 \times 16.5$	B32562H3155+***	2640	2800	1200
		2.2	$10.7 \times 12.8 \times 16.5$	B32562H3225+000	_	_	800
		3.3	$13.9\times14.5\times16.5$	B32562H3335+000	_	_	600
400	200	0.22	$4.7 \times 7.5 \times 16.5$	B32562J6224+***	4960	5200	3400
		0.33	$6.0 \times 8.3 \times 16.5$	B32562J6334+***	3840	4000	2000
		0.47	$7.3 \times 9.3 \times 16.5$	B32562J6474+***	3160	3600	1800
		0.68	$8.9 \times 10.8 \times 16.5$	B32562H6684+***	2560	2800	1200
		1.0	$10.9 \times 12.5 \times 16.5$	B32562H6105+000	_	_	800
		1.5	$13.7 \times 15.2 \times 16.5$	B32562H6155+000	_	_	400
630	350	0.22	$9.2 \times 12.2 \times 16.5$	B32562H8224+000	_	_	1400
		0.33	$11.2 \times 14.2 \times 16.5$	B32562H8334+000	_	_	1000
		0.47	$13.5\times16.3\times16.5$	B32562H8474+000	_	_	720

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further E series and intermediate capacitance values on request.

Special dimensions available on request.

For corresponding design rules, refer to chapter "General technical information", section 1.3.2.

#### Composition of ordering code

+ = Capacitance tolerance code:

 $M = \pm 20\%$ 

 $K = \pm 10\%$ 

 $J = \pm 5\%$ 

\*\*\* = Packaging code:

289 = Ammo pack

189 = Reel





#### General purpose (stacked) SilverCap™

#### Ordering codes and packing units (lead spacing 22.5 mm)

$V_R$	$V_{RMS}$	C <sub>R</sub>	Max. dimensions	Ordering code	Untaped
	f ≤60 Hz		$w \times h \times l$	(composition see below)	
V DC	V AC	μF	mm		pcs./MOQ
100	63	6.8	$7.0\times10.5\times24.0$	B32563J1685+000	3680
		10	$8.6 \times 12.2 \times 24.0$	B32563J1106+000	3840
		15	$10.9 \times 14.0 \times 24.0$	B32563J1156+000	2480
		22	$12.8 \times 17.2 \times 24.0$	B32563J1226+000	1440
250	160	2.2	$8.3 \times 11.2 \times 24.0$	B32563J3225+000	2960
		3.3	$10.1 \times 13.5 \times 24.0$	B32563J3335+000	2800
		4.7	$12.2 \times 15.5 \times 24.0$	B32563J3475+000	1560
400	200	1.0	$8.3 \times 11.2 \times 24.0$	B32563J6105+000	3400
		1.5	$10.3 \times 13.2 \times 24.0$	B32563J6155+000	2640
		2.2	$12.6\times15.5\times24.0$	B32563J6225+000	1440

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further E series and intermediate capacitance values on request.

Special dimensions available on request.

For corresponding design rules, refer to chapter "General technical information", section 1.3.2.

#### Composition of ordering code

+ = Capacitance tolerance code:

 $M = \pm 20\%$ 

 $K = \pm 10\%$ 

 $J = \pm 5\%$ 

Packaging code:





#### Ordering codes and packing units (lead spacing 27.5 mm)

$V_R$	$V_{RMS}$	C <sub>R</sub>	Max. dimensions	Ordering code	Untaped
	f ≤60 Hz		$w \times h \times l$	(composition see below)	
V DC	V AC	μF	mm		pcs./MOQ
100	63	10	$7.6 \times 11.0 \times 29.0$	B32564J1106+000	2720
		15	$9.1\times13.5\times29.0$	B32564J1156+000	1720
		22	$11.0 \times 16.0 \times 29.0$	B32564J1226+000	1280
		33	$13.0\times19.8\times29.0$	B32564J1336+000	1440
250	160	3.3	$7.9\times14.0\times29.0$	B32564J3335+000	3000
		4.7	$9.6\times15.8\times29.0$	B32564J3475+000	1600
		6.8	$11.9 \times 18.0 \times 29.0$	B32564J3685+000	1200
		10	$13.8 \times 22.5 \times 29.0$	B32564J3106+000	1120
400	200	1.5	$7.8\times14.2\times29.0$	B32564J6155+000	3000
		2.2	$9.6\times16.4\times29.0$	B32564J6225+000	1600
		3.3	$12.2 \times 18.8 \times 29.0$	B32564J6335+000	1320
		4.7	$14.2 \times 22.8 \times 29.0$	B32564J6475+000	1040
420	200	4.7	$16.0\times20.0\times29.0$	B32564T6475K000	1160
		6.8	$16.0 \times 20.0 \times 29.0$	B32564T6685K000	1160

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further E series and intermediate capacitance values on request.

Special dimensions available on request.

For corresponding design rules, refer to chapter "General technical information", section 1.3.2. The technical data given on page 10 do not apply to 420 V series. Please contact your nearest TDK representative if you need further information.

#### Composition of ordering code

+ = Capacitance tolerance code:

 $M = \pm 20\%$ 

 $K = \pm 10\%$ 

 $J = \pm 5\%$ 

Packaging code:





## General purpose (stacked) SilverCap™

#### **Technical data**

Reference standard: IEC 60384-2:2005. All data given at T = 20 °C, unless otherwise specified.

		3	,		<u> </u>	
Operating temperature	Max. operating temperature T <sub>op,max</sub> +125 °C					
range	Upper catego			+125 °C		
	Lower category temperature T <sub>min</sub> −55 °C					
	Rated temperature T <sub>R</sub> +85 °C					
Dissipation factor $\tan \delta$ (in 10 <sup>-3</sup> )	at	$C_R \le 0.1 \ \mu F$	$0.1  \mu F < 0$	C <sub>R</sub> ≤1 μF	$C_R > 1 \mu F$	
at 20 °C (upper limit values)	1 kHz	8	8		10	
	10 kHz	15	15		_	
	100 kHz	30	_		_	
Insulation resistance R <sub>ins</sub>	V <sub>R</sub>	$C_R \le 0.33 \ \mu F$		$C_R > 0.33 \mu$	F	
or time constant $\tau = C_R \cdot R_{ins}$	≤ 100 V DC	3750 MΩ		1250 s		
at 20 °C, rel. humidity ≤ 65%	≥ 250 V DC	7500 MΩ		2500 s		
(minimum as-delivered values)						
DC test voltage	1.4 · V <sub>R</sub> , 2 s					
Category voltage V <sub>C</sub>	T <sub>op</sub> (°C)	DC voltage derating		AC voltage	derating	
(continuous operation with	$T_{op} \le 85$	$V_C = V_R$		V <sub>C,RMS</sub> =V <sub>RMS</sub>	S	
V <sub>DC</sub> or V <sub>AC</sub> at f ≤ 60 Hz)	85 <t<sub>op≤125</t<sub>	$V_{\rm C} = V_{\rm R} \cdot (165 - T_{\rm op})/80$		$V_{C,RMS} = V_{RMS} \cdot (165 - T_{op})/80$		
Operating voltage $V_{\text{op}}$ for	T <sub>op</sub> (°C)	DC voltage (n	nax. hours)	AC voltage (max. hours)		
short operating periods	$T_{op} \le 100$	$V_{op} = 1.25 \cdot V_C (2000 \text{ h})$		$V_{op} = 1.0 \cdot V_{C,RMS} (2000 \text{ h})$		
$(V_{DC} \text{ or } V_{AC} \text{ at } f \le 60 \text{ Hz})$	100 <t<sub>op≤125</t<sub>	$V_{op} = 1.25 \cdot V$	<sub>C</sub> (1000 h)	$V_{op} = 1.0 \cdot V_{C,RMS} (1000 \text{ h})$		
Reliability:						
Failure rate $\lambda$	2 fit (≤ 2 · 10 <sup>-</sup>	$^9$ /h) at 0.5 $\cdot$ \	/ <sub>R</sub> , 40 °C			
Service life t <sub>SL</sub>	100 000 h at	1.0 · V <sub>R</sub> , 85 °C				
	For conversion to other operating conditions and temperatures,					
	refer to chapte	er "Reliability"				
Failure criteria:						
Total failure	Short circuit o	r open circuit				
Failure due to variation	Capacitance of	change  ∆C/C	;	> 10%		
of parameters	Dissipation factor $tan \delta$			> 2 · upper limit value		
	Insulation resistance R <sub>ins</sub>			$<$ 150 M $\Omega$ (C <sub>R</sub> $\leq$ 0.33 $\mu$ F)		
	or time constant $\tau = C_R \cdot R_{ins}$			$< 50 \text{ s } (C_R > 0.33 \mu\text{F})$		





#### Pulse handling capability

"dV/dt" represents the maximum permissible voltage change per unit of time for non-sinusoidal voltages, expressed in V/μs.

"k<sub>0</sub>" represents the maximum permissible pulse characteristic of the waveform applied to the capacitor, expressed in V<sup>2</sup>/μs.

#### Note:

The values of dV/dt and  $k_0$  provided below must not be exceeded in order to avoid damaging the capacitor. These parameters are given for isolated pulses in such a way that the heat generated by one pulse will be completely dissipated before applying the next pulse. For a train of pulses, please refer to the curves of permissible AC voltage-current versus frequency.

#### dV/dt values

Lead spa	acing	7.5 mm	15 mm	22.5 mm	27.5 mm			
$V_R$	V <sub>RMS</sub>							
V DC	V AC	dV/dt in V/μs						
63	40	120	_	_	_			
100	63	150	50	50	25			
250	160	200	100	100	50			
400	200	275	125	125	60			
420	200	_	_	_	60			
630	350	_	150	_	_			
630	400	320	_	_	_			

#### k<sub>0</sub> values

Lead spacing		7.5 mm	15 mm	22.5 mm	27.5 mm	
$\overline{V_R}$	V <sub>RMS</sub>		•	•	•	
V DC	V AC	k <sub>0</sub> in V²/μs				
63	40	15 000	_	_	_	
100	63	30 000	10 000	10 000	5 000	
250	160	100 000	50 000	50 000	25 000	
400	200	220 000	100 000	100 000	50 000	
420	200	_	_	_	50 000	
630	350	_	190 000	_	_	
630	400	400 000	_	_	_	

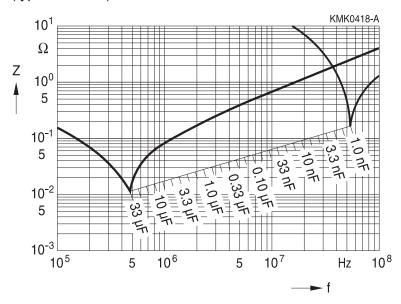




## General purpose (stacked) SilverCap™

## Impedance Z versus frequency f

(typical values)







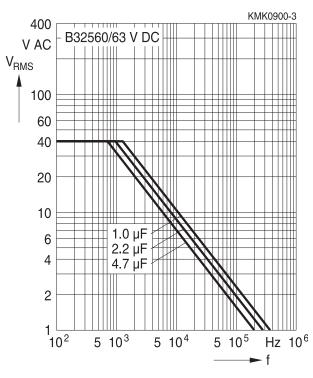
#### General purpose (stacked) SilverCap™

# Permissible AC voltage V<sub>RMS</sub> versus frequency f (for sinusoidal waveforms, T<sub>A</sub> ≤55 °C)

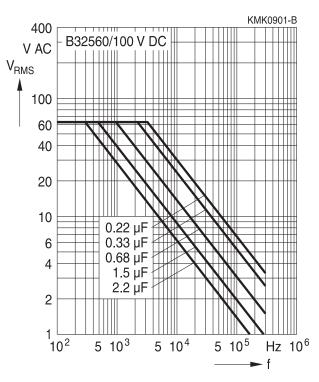
For T<sub>A</sub> >55 °C, please refer to "General technical information", section 3.2.3.

#### Lead spacing 7.5 mm

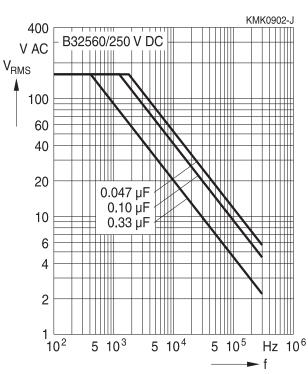
63 V DC/40 V AC



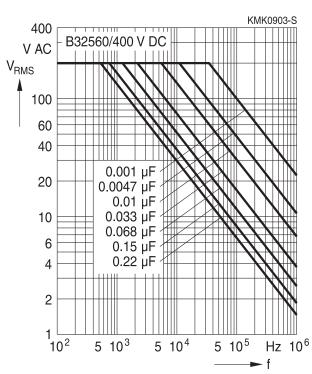
#### 100 V DC/63 V AC



250 V DC/160 V AC



400 V DC/200 V AC







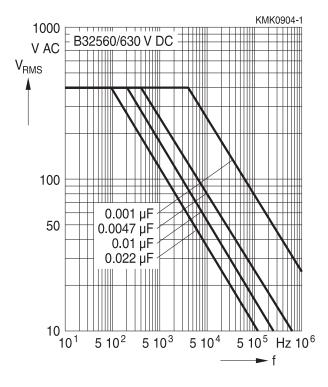
## General purpose (stacked) SilverCap™

## Permissible AC voltage $V_{RMS}$ versus frequency f (for sinusoidal waveforms, $T_A \le 55$ °C)

For  $T_A > 55\ ^{\circ}C$ , please refer to "General technical information", section 3.2.3.

## Lead spacing 7.5 mm

630 V DC/400 V AC







#### General purpose (stacked) SilverCap™

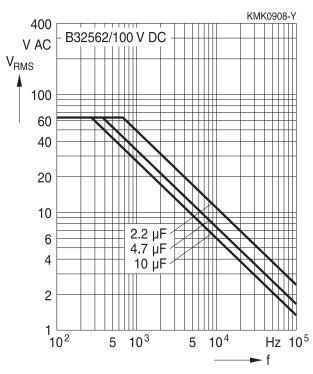
# MKT

#### Permissible AC voltage V<sub>RMS</sub> versus frequency f (for sinusoidal waveforms, T<sub>A</sub> ≤55 °C)

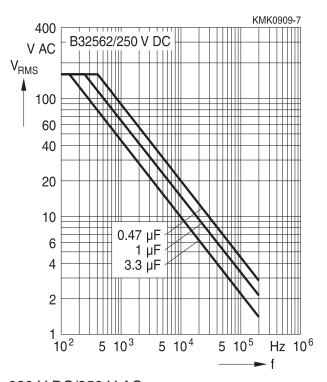
For T<sub>A</sub> >55 °C, please refer to "General technical information", section 3.2.3.

## Lead spacing 15 mm

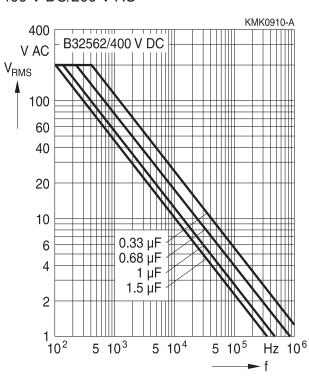
100 V DC/63 V AC



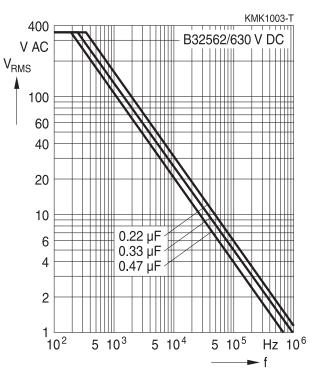
#### 250 V DC/160 V AC



400 V DC/200 V AC



630 V DC/350 V AC







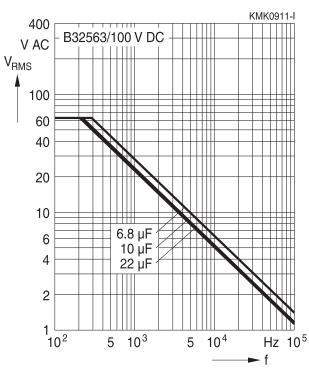
## General purpose (stacked) SilverCap™

## Permissible AC voltage V<sub>RMS</sub> versus frequency f (for sinusoidal waveforms, T<sub>A</sub> ≤55 °C)

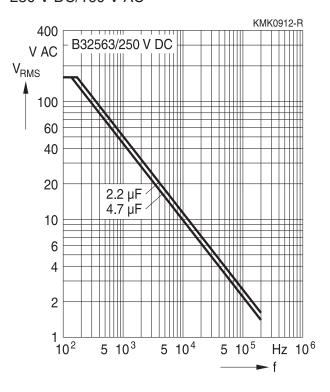
For  $T_A > 55$  °C, please refer to "General technical information", section 3.2.3.

## Lead spacing 22.5 mm

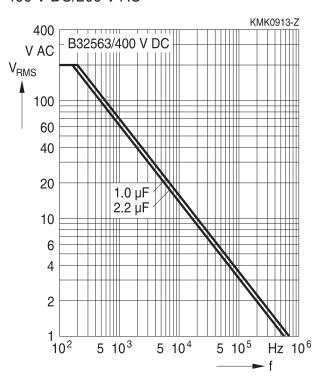
100 V DC/63 V AC



#### 250 V DC/160 V AC



#### 400 V DC/200 V AC







#### General purpose (stacked) SilverCap™

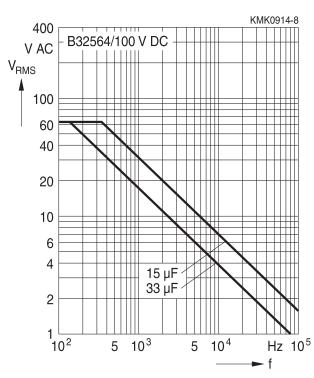


## Permissible AC voltage V<sub>RMS</sub> versus frequency f (for sinusoidal waveforms, T<sub>A</sub> ≤55 °C)

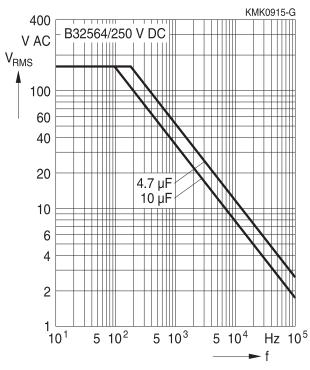
For  $T_A > 55\ ^{\circ}C$ , please refer to "General technical information", section 3.2.3.

#### Lead spacing 27.5 mm

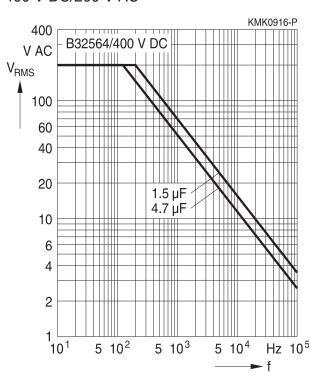
100 V DC/63 V AC



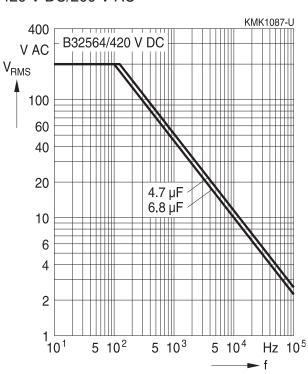
#### 250 V DC/160 V AC



400 V DC/200 V AC



420 V DC/200 V AC





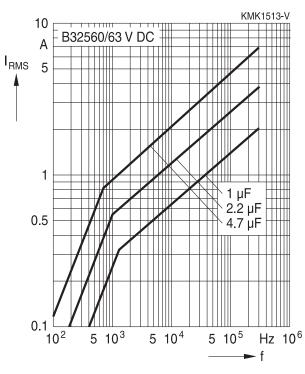


#### General purpose (stacked) SilverCap™

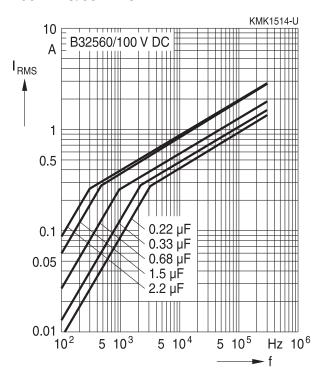
## Permissible current I<sub>RMS</sub> versus frequency f (for sinusoidal waveforms, T<sub>A</sub> ≤55 °C)

#### Lead spacing 7.5 mm

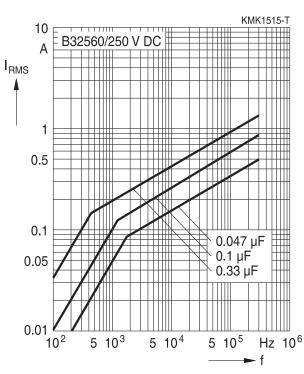
63 V DC/40 V AC



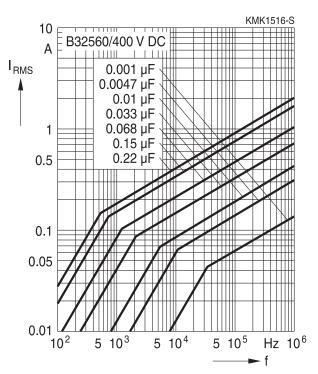
#### 100 V DC/63 V AC



250 V DC/160 V AC

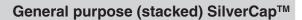


400 V DC/200 V AC







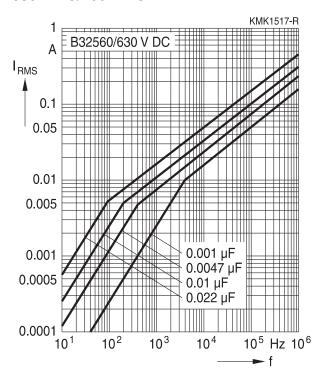




Permissible current  $I_{RMS}$  versus frequency f (for sinusoidal waveforms,  $T_A \leq 55$  °C)

## Lead spacing 7.5 mm

630 V DC/400 V AC





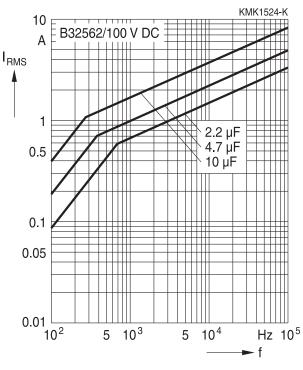


#### General purpose (stacked) SilverCap™

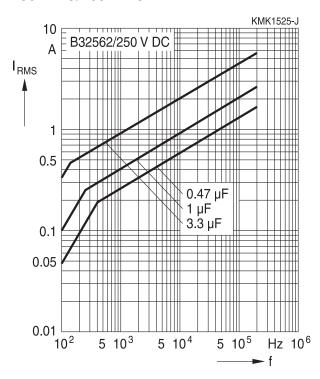
#### Permissible current I<sub>RMS</sub> versus frequency f (for sinusoidal waveforms, T<sub>A</sub> ≤55 °C)

#### Lead spacing 15 mm

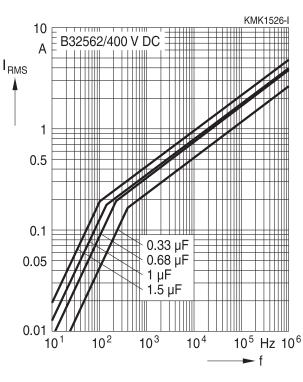
100 V DC/63 V AC



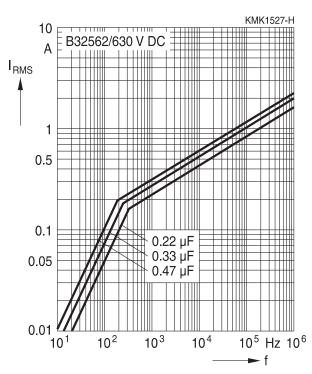
#### 250 V DC/160 V AC



400 V DC/200 V AC



630 V DC/350 V AC







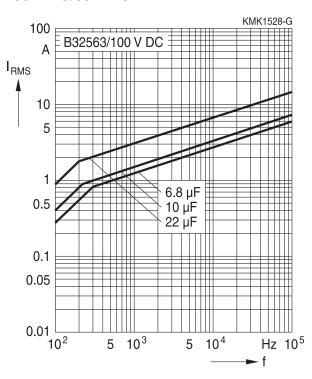
#### General purpose (stacked) SilverCap™



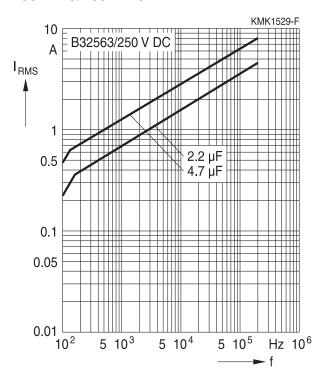
#### Permissible current I<sub>RMS</sub> versus frequency f (for sinusoidal waveforms, T<sub>A</sub> ≤55 °C)

#### Lead spacing 22.5 mm

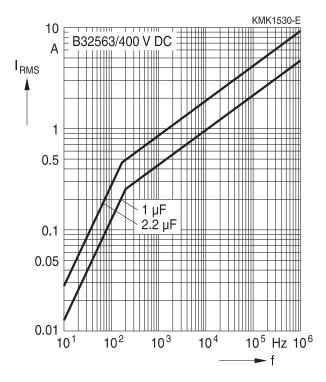
100 V DC/63 V AC



#### 250 V DC/160 V AC



#### 400 V DC/200 V AC





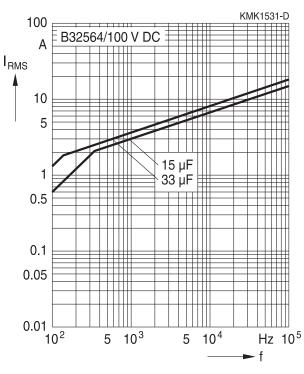


#### General purpose (stacked) SilverCap™

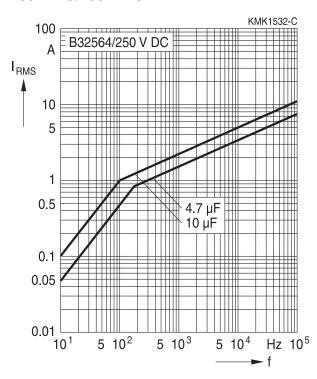
#### Permissible current I<sub>RMS</sub> versus frequency f (for sinusoidal waveforms, T<sub>A</sub> ≤55 °C)

#### Lead spacing 27.5 mm

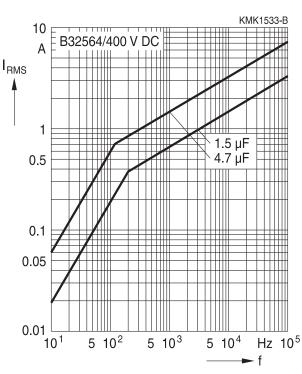
100 V DC/63 V AC



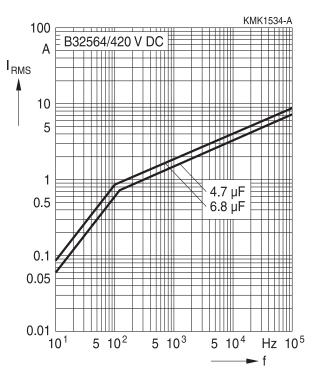
#### 250 V DC/160 V AC



400 V DC/200 V AC



420 V DC/200 V AC







## General purpose (stacked) SilverCap $^{\text{TM}}$

#### **Testing and Standards**

Test	Reference	Conditions of test		Performance requirements
	IEC 60384-2:2005	Voltage proof, 1.4 V <sub>F</sub> Insulation resistance Capacitance, C Dissipation factor, ta	e, R <sub>ins</sub>	Within specified limits
Robust- ness of termina- tions	IEC 60068-2-21:2006	Tensile strength (test Ua1) Wire diameter Tensile force $0.3 < d_1 \le 0.5 \text{ mm}$ $0.5 < d_1 \le 0.8 \text{ mm}$ $10 \text{ N}$		No visible damage Capacitance and $\delta$ within specified limits
Resistance to soldering heat	IEC 60068-2-20:2008, test Tb, method 1A	Solder bath tempera immersion for 4 seconds (lead space 10 seconds (lead space	cing ≤10mm)	$\Delta C/C_0 \le 2\%$ $ \Delta \tan \delta  \le 0.003$ for $C \le 1 \mu F$ $ \Delta \tan \delta  \le 0.002$ for $C > 1 \mu F$
Rapid change of temperature	IEC 60384-2:2005	$T_A$ = lower category t $T_B$ = upper category Five cycles, duration	temperature	$\Delta C/C_0 \le 5\%$ $ \Delta \tan \delta  \le 0.003 \text{ for } C \le 1 \mu\text{F}$ $ \Delta \tan \delta  \le 0.002 \text{ for } C > 1 \mu\text{F}$ $ A \tan \delta  \le 0.002 \text{ for } C > 1 \mu\text{F}$ $ A \cot \delta  \le 0.002 \text{ for } C > 1 \mu\text{F}$
Vibration	IEC 60384-2:2005	Test Fc: vibration sin Displacement: 0.75 r Accleration: 98 m/s <sup>2</sup> Frequency: 10 Hz Test duration: 3 ortho 2 hours each axe	mm 500 Hz	No visible damage
Bump	IEC 60384-2:2005	Test Eb: Total 4000 390 m/s² mounted or Duration: 6 ms		$\Delta$ C/C <sub>0</sub> $\leq$ 5% $ \Delta \tan \delta  \leq$ 0.003 for C $\leq$ 1 $\mu$ F $ \Delta \tan \delta  \leq$ 0.002 for C > 1 $\mu$ F R <sub>ins</sub> $\geq$ 50% of initial limit
Climatic sequence	IEC 60384-2:2005	Dry heat Tb / 16 h Damp heat cyclic, 1st +55 °C / 24 h / 95% Cold Ta / 2 h Damp heat cyclic, 5 c +55 °C / 24 h / 95%	100% RH	$\Delta C/C_0 \le 5\%$ $ \Delta \tan \delta  \le 0.005 \text{ for } C \le 1 \mu\text{F}$ $ \Delta \tan \delta  \le 0.003 \text{ for } C > 1 \mu\text{F}$ $R_{\text{ins}} \ge 50\% \text{ of initial limit}$
Damp heat, steady state	IEC 60384-2:2005	Test Ca 40 °C / 93% RH / 56	days	No visible damage $\begin{split}  \Delta C/C_0  &\leq \!\! 5\% \\  \Delta \tan \delta  &\leq \!\! 0.005 \\ R_{\text{ins}} &\geq \!\! 50\% \text{ of initial limit} \end{split}$





#### General purpose (stacked) SilverCap™

Test	Reference	Conditions of test	Performance requirements
Endurance A	IEC 60384-2:2005	85 °C / 1.25 V <sub>R</sub> / 2000 hours	No visible damage $\begin{split}  \Delta C/C_0  &\leq 5\% \\  \Delta \tan \delta  &\leq 0.003 \text{ for } C \leq 1  \mu\text{F} \\  \Delta \tan \delta  &\leq 0.002 \text{ for } C > 1  \mu\text{F} \\ R_{\text{ins}} &\geq 50\% \text{ of initial limit} \end{split}$
Endurance B	IEC 60384-2:2005	125 °C / 1.25 V <sub>C</sub> / 2000 hours	No visible damage $\begin{split}  \Delta C/C_0  &\leq 5\% \\  \Delta \tan \delta  &\leq &0.003 \text{ for } C \leq 1  \mu\text{F} \\  \Delta \tan \delta  &\leq &0.002 \text{ for } C > &1  \mu\text{F} \\ R_{\text{ins}} &\geq &50\% \text{ of initial limit} \end{split}$

#### **Mounting guidelines**

#### 1 **Soldering**

#### 1.1 Solderability of leads

The solderability of terminal leads is tested to IEC 60068-2-20, test Ta, method 1.

Before a solderability test is carried out, terminals are subjected to accelerated ageing (to IEC 60068-2-2, test Ba: 4 h exposure to dry heat at 155 °C). Since the ageing temperature is far higher than the upper category temperature of the capacitors, the terminal wires should be cut off from the capacitor before the ageing procedure to prevent the solderability being impaired by the products of any capacitor decomposition that might occur.

Solder bath temperature	235 ±5 °C
Soldering time	2.0 ±0.5 s
Immersion depth	2.0 + 0/-0.5 mm from capacitor body or seating plane
Evaluation criteria:	
Visual inspection	Wetting of wire surface by new solder ≥90%, free-flowing solder





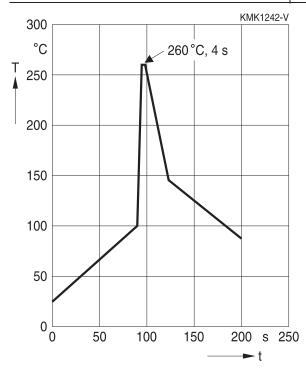


## General purpose (stacked) SilverCap™

#### 1.2 Resistance to soldering heat

Resistance to soldering heat is tested to IEC 60068-2-20, test Tb, method 1. Conditions:

Serie	s	Solder bath temperature	Soldering time
MKT	boxed (except $2.5 \times 6.5 \times 7.2$ mm) coated uncoated (lead spacing >10 mm)	260 ±5 °C	10 ±1 s
MFP			
MKP	(lead spacing >7.5 mm)		
MKT	boxed (case $2.5 \times 6.5 \times 7.2$ mm)		5 ±1 s
MKP	(lead spacing ≤7.5 mm)		<4 s
MKT	uncoated (lead spacing ≤10 mm) insulated (B32559)		recommended soldering profile for MKT uncoated (lead spacing ≤ 10 mm) and insulated (B32559)



Immersion depth	2.0 +0/-0.5 mm from capacitor body or seating plane
Shield	Heat-absorbing board, (1.5 $\pm$ 0.5) mm thick, between
	capacitor body and liquid solder
Evaluation criteria:	
Visual inspection	No visible damage
10/0	2% for MKT/MKP/MFP
$\Delta C/C_0$	5% for EMI suppression capacitors
tan δ	As specified in sectional specification





#### General purpose (stacked) SilverCap™

#### 1.3 General notes on soldering

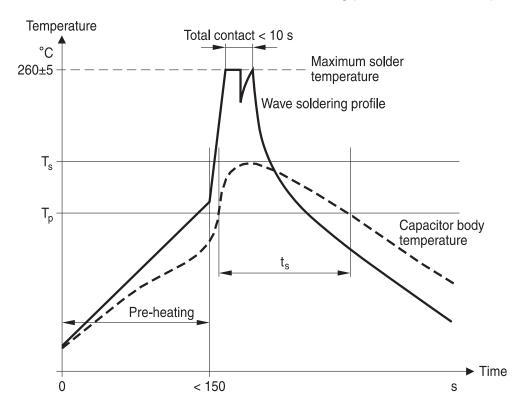
Permissible heat exposure loads on film capacitors are primarily characterized by the upper category temperature  $T_{\text{max}}$ . Long exposure to temperatures above this type-related temperature limit can lead to changes in the plastic dielectric and thus change irreversibly a capacitor's electrical characteristics. For short exposures (as in practical soldering processes) the heat load (and thus the possible effects on a capacitor) will also depend on other factors like:

- Pre-heating temperature and time
- Forced cooling immediately after soldering
- Terminal characteristics: diameter, length, thermal resistance, special configurations (e.g. crimping)
- Height of capacitor above solder bath
- Shadowing by neighboring components
- Additional heating due to heat dissipation by neighboring components
- Use of solder-resist coatings

The overheating associated with some of these factors can usually be reduced by suitable countermeasures. For example, if a pre-heating step cannot be avoided, an additional or reinforced cooling process may possibly have to be included.

#### Recommendations

As a reference, the recommended wave soldering profile for our film capacitors is as follows:



T<sub>s</sub>: Capacitor body maximum temperature at wave soldering

T<sub>p</sub>: Capacitor body maximum temperature at pre-heating

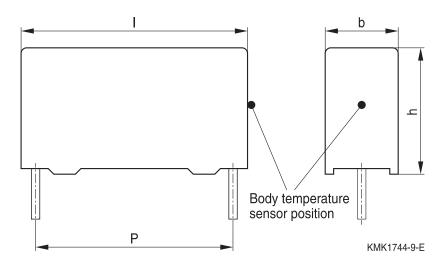
KMK1745-A-E











Body temperature should follow the description below:

MKT capacitor

During pre-heating: T<sub>p</sub> ≤125 °C

During soldering: T<sub>s</sub> ≤160 °C, t<sub>s</sub> ≤45 s

When SMD components are used together with leaded ones, the film capacitors should not pass into the SMD adhesive curing oven. The leaded components should be assembled after the SMD curing step.

Leaded film capacitors are not suitable for reflow soldering.

In order to ensure proper conditions for manual or selective soldering, the body temperature of the capacitor ( $T_s$ ) must be  $\leq 120$  °C.

One recommended condition for manual soldering is that the tip of the soldering iron should be <360 °C and the soldering contact time should be no longer than 3 seconds.

For uncoated MKT capacitors with lead spacings ≤10 mm (B32560/B32561) the following measures are recommended:

- pre-heating to not more than 110 °C in the preheater phase
- rapid cooling after soldering

Please refer to our Film Capacitors Data Book in case more details are needed.





#### General purpose (stacked) SilverCap™

#### Cautions and warnings

- Do not exceed the upper category temperature (UCT).
- Do not apply any mechanical stress to the capacitor terminals.
- Avoid any compressive, tensile or flexural stress.
- Do not move the capacitor after it has been soldered to the PC board.
- Do not pick up the PC board by the soldered capacitor.
- Do not place the capacitor on a PC board whose PTH hole spacing differs from the specified lead spacing.
- Do not exceed the specified time or temperature limits during soldering.
- Avoid external energy inputs, such as fire or electricity.
- Avoid overload of the capacitors.
- Consult us if application is with severe temperature and humidity condition.
- There are no serviceable or repairable parts inside the capacitor. Opening the capacitor or any attempts to open or repair the capacitor will void the warranty and liability of TDK Electronics.
- Please note that the standards referred to in this publication may have been revised in the meantime.

The table below summarizes the safety instructions that must always be observed. A detailed description can be found in the relevant sections of the chapters "General technical information" and "Mounting guidelines".

Topic	Safety information	Reference chapter "General technical information"
Storage conditions	Make sure that capacitors are stored within the specified range of time, temperature and humidity conditions.	4.5 "Storage conditions"
Flammability	Avoid external energy, such as fire or electricity (passive flammability), avoid overload of the capacitors (active flammability) and consider the flammability of materials.	5.3 "Flammability"
Resistance to vibration	Do not exceed the tested ability to withstand vibration. The capacitors are tested to IEC 60068-2-6:2007. TDK Electronics offers film capacitors specially designed for operation under more severe vibration regimes such as those found in automotive applications. Consult our catalog "Film Capacitors for Automotive Electronics".	5.2 "Resistance to vibration"





Topic	Safety information	Reference chapter "Mounting guidelines"
Soldering	Do not exceed the specified time or temperature limits during soldering.	1 "Soldering"
Cleaning	Use only suitable solvents for cleaning capacitors.	2 "Cleaning"
Embedding of capacitors in finished assemblies	When embedding finished circuit assemblies in plastic resins, chemical and thermal influences must be taken into account.  Caution: Consult us first, if you also wish to embed other uncoated component types!	3 "Embedding of capacitors in finished assemblies"

#### Display of ordering codes for TDK Electronics products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications, on the company website, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products.

Detailed information can be found on the Internet under www.tdk-electronics.tdk.com/orderingcodes.

#### Correlation of data sheet values and modelling tool outputs

Data sheet values and results of design tools may deviate as they have not been derived in the same context.

While data sheets show individual parameter statements without considering a possible dependency to other parameters. Tools model a complete given scenario as input and processed inside the tool.

Furthermore as we constantly strive to improve our models, the results of tools can change over time and be a non-binding indication only.





## General purpose (stacked) SilverCap™

## Symbols and terms

Symbol	English	German
α	Heat transfer coefficient	Wärmeübergangszahl
$\alpha_{C}$	Temperature coefficient of capacitance	Temperaturkoeffizient der Kapazität
Α	Capacitor surface area	Kondensatoroberfläche
$\beta_{C}$	Humidity coefficient of capacitance	Feuchtekoeffizient der Kapazität
С	Capacitance	Kapazität
$C_R$	Rated capacitance	Nennkapazität
ΔC	Absolute capacitance change	Absolute Kapazitätsänderung
ΔC/C	Relative capacitance change (relative deviation of actual value)	Relative Kapazitätsänderung (relative Abweichung vom Ist-Wert)
$\Delta C/C_R$	Capacitance tolerance (relative deviation from rated capacitance)	,
dt	Time differential	Differentielle Zeit
Δt	Time interval	Zeitintervall
ΔΤ	Absolute temperature change (self-heating)	Absolute Temperaturänderung (Selbsterwärmung)
∆tan δ	Absolute change of dissipation factor	Absolute Änderung des Verlustfaktors
$\DeltaV$	Absolute voltage change	Absolute Spannungsänderung
dV/dt	Time differential of voltage function (rate of voltage rise)	Differentielle Spannungsänderung (Spannungsflankensteilheit)
ΔV/Δt	Voltage change per time interval	Spannungsänderung pro Zeitintervall
E	Activation energy for diffusion	Aktivierungsenergie zur Diffusion
ESL	Self-inductance	Eigeninduktivität
ESR	Equivalent series resistance	Ersatz-Serienwiderstand
f	Frequency	Frequenz
f <sub>1</sub>	Frequency limit for reducing permissible AC voltage due to thermal limits	Grenzfrequenz für thermisch bedingte Reduzierung der zulässigen Wechselspannung
f <sub>2</sub>	Frequency limit for reducing permissible AC voltage due to current limit	Grenzfrequenz für strombedingte Reduzierung der zulässigen Wechselspannung
f <sub>r</sub>	Resonant frequency	Resonanzfrequenz
$F_{D}$	Thermal acceleration factor for diffusion	Therm. Beschleunigungsfaktor zur Diffusion
F <sub>T</sub>	Derating factor	Deratingfaktor
i	Current (peak)	Stromspitze
I <sub>C</sub>	Category current (max. continuous current)	Kategoriestrom (max. Dauerstrom)





## General purpose (stacked) SilverCap™

Symbol	English	German
I <sub>RMS</sub>	(Sinusoidal) alternating current,	(Sinusförmiger) Wechselstrom
	root-mean-square value	
$i_z$	Capacitance drift	Inkonstanz der Kapazität
$k_0$	Pulse characteristic	Impulskennwert
Ls	Series inductance	Serieninduktivität
λ	Failure rate	Ausfallrate
$\lambda_{0}$	Constant failure rate during useful	Konstante Ausfallrate in der
	service life	Nutzungsphase
$\lambda_{\text{test}}$	Failure rate, determined by tests	Experimentell ermittelte Ausfallrate
$P_{diss}$	Dissipated power	Abgegebene Verlustleistung
$P_{gen}$	Generated power	Erzeugte Verlustleistung
Q	Heat energy	Wärmeenergie
ρ	Density of water vapor in air	Dichte von Wasserdampf in Luft
R	Universal molar constant for gases	Allg. Molarkonstante für Gas
R	Ohmic resistance of discharge circuit	Ohmscher Widerstand des
		Entladekreises
$R_{i}$	Internal resistance	Innenwiderstand
$R_{ins}$	Insulation resistance	Isolationswiderstand
$R_P$	Parallel resistance	Parallelwiderstand
$R_s$	Series resistance	Serienwiderstand
S	severity (humidity test)	Schärfegrad (Feuchtetest)
t	Time	Zeit
Т	Temperature	Temperatur
τ	Time constant	Zeitkonstante
$tan \ \delta$	Dissipation factor	Verlustfaktor
$tan \; \delta_{\scriptscriptstyle D}$	Dielectric component of dissipation factor	Dielektrischer Anteil des Verlustfaktors
$tan \; \delta_{\scriptscriptstyle P}$	Parallel component of dissipation factor	Parallelanteil des Verlfustfaktors
tan $\delta_s$	Series component of dissipation factor	Serienanteil des Verlustfaktors
$T_A$	Temperature of the air surrounding the component	Temperatur der Luft, die das Bauteil umgibt
$T_{max}$	Upper category temperature	Obere Kategorietemperatur
$T_{min}$	Lower category temperature	Untere Kategorietemperatur
t <sub>OL</sub>	Operating life at operating temperature	Betriebszeit bei Betriebstemperatur und
	and voltage	-spannung
$T_{op}$	Operating temperature, $T_A + \Delta T$	Beriebstemperatur, $T_A + \Delta T$
T <sub>R</sub>	Rated temperature	Nenntemperatur
$T_{ref}$	Reference temperature	Referenztemperatur
$t_{SL}$	Reference service life	Referenz-Lebensdauer





## General purpose (stacked) SilverCap™

Symbol	English	German
$V_{AC}$	AC voltage	Wechselspannung
$V_{C}$	Category voltage	Kategoriespannung
$V_{C,RMS}$	Category AC voltage	(Sinusförmige)
		Kategorie-Wechselspannung
$V_{CD}$	Corona-discharge onset voltage	Teilentlade-Einsatzspannung
$V_{ch}$	Charging voltage	Ladespannung
$V_{DC}$	DC voltage	Gleichspannung
$V_{\sf FB}$	Fly-back capacitor voltage	Spannung (Flyback)
$V_{i}$	Input voltage	Eingangsspannung
$V_{o}$	Output voltage	Ausgangssspannung
$V_{op}$	Operating voltage	Betriebsspannung
$V_p$	Peak pulse voltage	Impuls-Spitzenspannung
$V_{pp}$	Peak-to-peak voltage Impedance	Spannungshub
$V_R$	Rated voltage	Nennspannung
Ŷ <sub>R</sub>	Amplitude of rated AC voltage	Amplitude der Nenn-Wechselspannung
$V_{RMS}$	(Sinusoidal) alternating voltage,	(Sinusförmige) Wechselspannung
	root-mean-square value	
$V_{SC}$	S-correction voltage	Spannung bei Anwendung "S-correction"
$V_{sn}$	Snubber capacitor voltage	Spannung bei Anwendung
		"Beschaltung"
Z	Impedance	Scheinwiderstand
е	Lead spacing	Rastermaß



#### **Important notes**

The following applies to all products named in this publication:

- 1. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application. As a rule, we are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether a product with the properties described in the product specification is suitable for use in a particular customer application.
- 2. We also point out that in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or lifesaving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
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- 6. Unless otherwise agreed in individual contracts, all orders are subject to our General Terms and Conditions of Supply.



#### **Important notes**

- 7. Our manufacturing sites serving the automotive business apply the IATF 16949 standard. The IATF certifications confirm our compliance with requirements regarding the quality management system in the automotive industry. Referring to customer requirements and customer specific requirements ("CSR") TDK always has and will continue to have the policy of respecting individual agreements. Even if IATF 16949 may appear to support the acceptance of unilateral requirements, we hereby like to emphasize that only requirements mutually agreed upon can and will be implemented in our Quality Management System. For clarification purposes we like to point out that obligations from IATF 16949 shall only become legally binding if individually agreed upon.
- 8. The trade names EPCOS, CarXield, CeraCharge, CeraDiode, CeraLink, CeraPad, CeraPlas, CSMP, CTVS, DeltaCap, DigiSiMic, ExoCore, FilterCap, FormFit, LeaXield, MiniBlue, MiniCell, MKD, MKK, ModCap, MotorCap, PCC, PhaseCap, PhaseCube, PhaseMod, PhiCap, PowerHap, PQSine, PQvar, SIFERRIT, SIFI, SIKOREL, SilverCap, SIMDAD, SiMic, SIMID, SineFormer, SIOV, ThermoFuse, WindCap, XieldCap are trademarks registered or pending in Europe and in other countries. Further information will be found on the Internet at www.tdk-electronics.tdk.com/trademarks.

Release 2020-06